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Power GaN Cascode Transistor 600 V, 150 m Ω

Features

- Fast Switching
- Extremely Low Q_{rr}
- Transphorm Inside
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

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V _{(BR)DSS}	R _{DS(ON)} TYP
600 V	150 mΩ @ 10 V

Para	Symbol	NDD	Unit			
Drain-to-Source Voltage			V _{DSS}	600	V	
Gate-to-Source Voltage			V _{GS}	±18	V	
Continuous Drain			I _D	17	А	
Current R _{0JC}	State	$T_C = 100^{\circ}C$		12		
Power Dissipation – $R_{\theta JC}$	Steady State	$T_C = 25^{\circ}C$	P _D	96	W	
Pulsed Drain Current	μ ⁻ μ ⁻		I _{DM}	60	A	
Operating Junction and Storage Temperature		T _J , T _{STG}	–55 to +150	°C		
Lead Temperature for	Τ _L	260	°C			

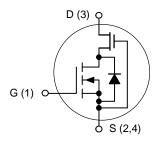
ABSOLUTE MAXIMUM RATINGS (T₁ = 25°C unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

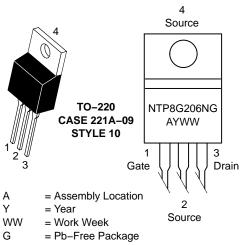
THERMAL RESISTANCE

Parameter	Symbol	Value	Unit
Junction-to-Case (Drain)	$R_{\theta JC}$	1.55	°C/W
Junction-to-Ambient Steady State	R_{\thetaJA}	62	°C/W





MARKING DIAGRAM & PIN ASSIGNMENT



ORDERING INFORMATION

Device	Package	Shipping
NTP8G206NG	TO-220 (Pb-Free)	50 Units / Rail

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise noted)

Characteristic	Symbol	Test Conditions	6	Min	Тур	Max	Unit
OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0 V, I _D = 1 r	nA	600			V
Drain-to-Source Leakage Current	I _{DSS}	$V_{DS} = 600 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	$T_J = 25^{\circ}C$		2.5	90	μΑ
			$T_J = 150^{\circ}C$		8.0		
Gate-to-Source Leakage Current	I _{GSS}	V _{GS} = ±18 V				±100	nA
ON CHARACTERISTICS (Note 1)							
Gate Threshold Voltage	V _{GS(TH)}	$V_{DS} = V_{GS}, I_{D} = 500$	Ο μΑ	1.6	2.1	2.6	V
Static Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 8 V, I _D = 11 A, T _J	j = 25°C		150	180	mΩ
		V _{GS} = 8 V, I _D = 11 A, T _J	= 175°C		340		
DYNAMIC CHARACTERISTICS							
Input Capacitance	C _{iss}	V _{DS} = 480 V, V _{GS} = 0 V, f = 1 MHz			760		pF
Output Capacitance	C _{oss}				44		
Reverse Transfer Capacitance	C _{rss}				5.0		
Effective output capacitance, energy related (Note 3)	C _{o(er)}	V_{GS} = 0 V, V_{DS} = 0 to 480 V			64		
Effective output capacitance, time related (Note 4)	C _{o(tr)}	I_D = constant, V_{GS} = 0 V, V_{DS} = 0 to 480 V			105		
Total Gate Charge	Qg				6.2	9.3	nC
Gate-to-Source Charge	Q _{gs}	V _{DS} = 100 V, I _D = 11 A, V ₀	_{GS} = 4.5 V		2.1		
Gate-to-Drain Charge	Q _{gd}				2.2		
SWITCHING CHARACTERISTICS (Note	e 2)						
Turn-on Delay Time	t _{d(on)}				6.2		ns
Rise Time	t _r	V = 480 V, I = 1	1 A,		4.5		
Turn-off Delay Time	t _{d(off)}	$V_{\rm GS} = 10 \text{ V}, \text{ R}_{\rm G} = 2 \Omega$			9.7		

SOURCE-DRAIN DIODE CHARACTERISTICS

Fall Time

Diode Forward Voltage	V _{SD}	$I_{S} = 11 \text{ A}, V_{GS} = 0 \text{ V}$	$T_J = 25^{\circ}C$	2.2	V
Reverse Recovery Time	t _{rr}	V _{GS} = 0 V, V _{DD} = 400 V		17	ns
Reverse Recovery Charge	Q _{rr}	$I_{\rm S} = 11 {\rm A}, {\rm d}_{\rm i}/{\rm d}_{\rm t} = 2000 {\rm d}_{\rm c}$) A/μs	53	nC

4.0

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

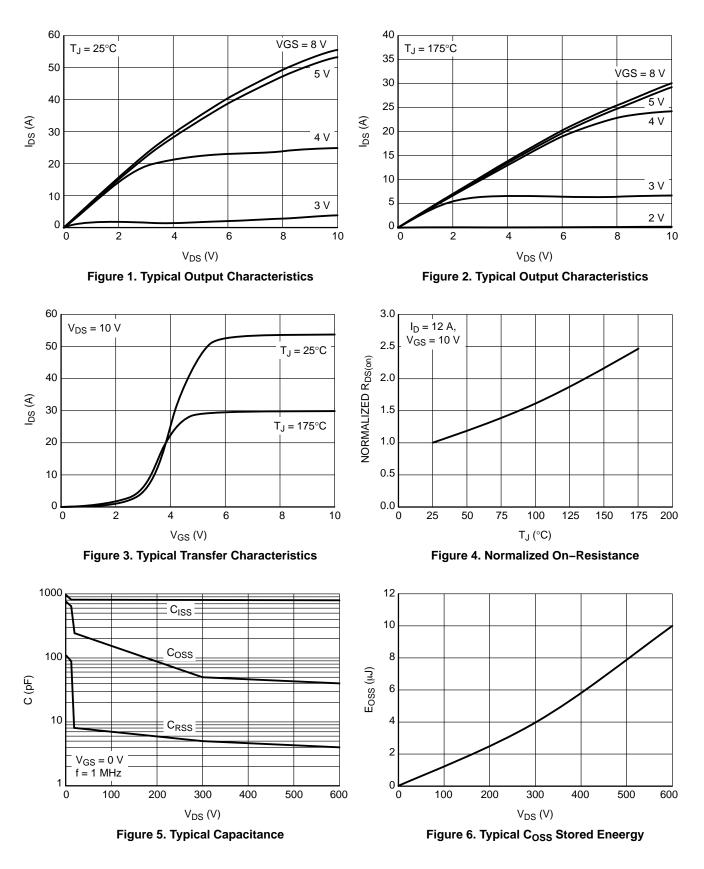
1. Pulse Width \leq 300 µs, Duty Cycle \leq 2%.

t_{d(off)}

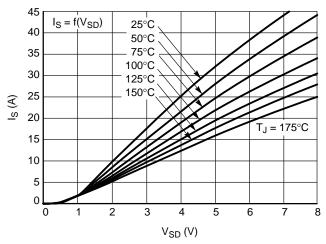
t_f

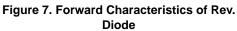
Pulse Width ≤ 300 µs, Duty Cycle ≤ 270.
Switching characteristics are independent of operating junction temperatures.
C_{o(er)} is a fixed capacitance that gives the same stored energy as C_{oss} while V_{DS} is rising from 0 to 80% V_{(BR)DSS}
C_{o(tr)} is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 to 80% V_{(BR)DSS}

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS





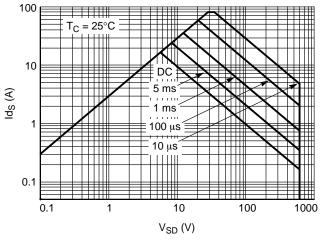
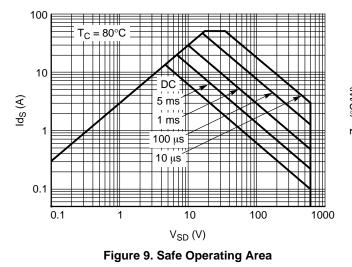


Figure 8. Safe Operating Area



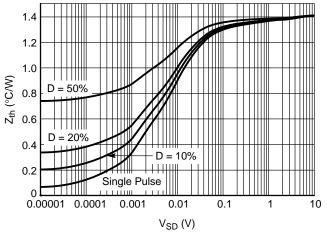


Figure 10. Transient Thermal Resistance

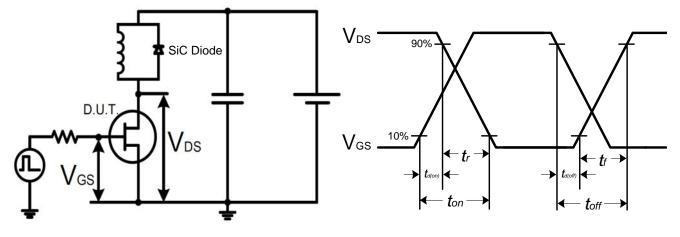


Figure 11. Switching Time Test Circuit

Figure 12. Switching Time Waveform

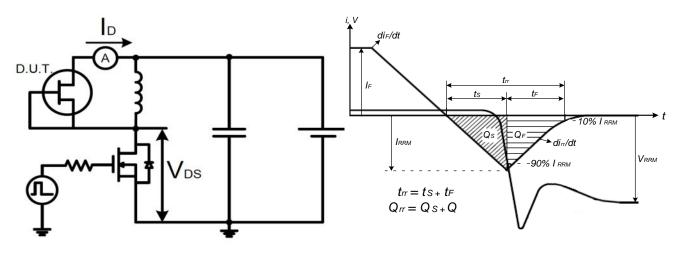
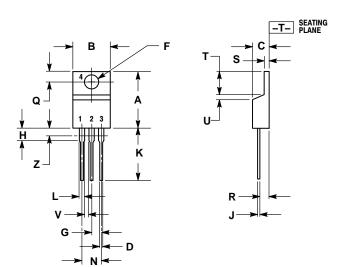


Figure 13. Test Circuit for Reverse Diode Characteristics

Figure 14. Diode Recovery Waveform

PACKAGE DIMENSIONS

TO-220 CASE 221A-09 **ISSUE AH**



NOTES:

DIMENSIONING AND TOLERANCING PER ANSI 2

VI4.5M, 1982. CONTROLLING DIMENSION: INCH. DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE 3. ALLOWED.

	INC	HES	MILLIMETERS		
DIM	MIN	MAX	MIN	MAX	
Α	0.570	0.620	14.48	15.75	
В	0.380	0.415	9.66	10.53	
C	0.160	0.190	4.07	4.83	
D	0.025	0.038	0.64	0.96	
F	0.142	0.161	3.61	4.09	
G	0.095	0.105	2.42	2.66	
Н	0.110	0.161	2.80	4.10	
J	0.014	0.024	0.36	0.61	
K	0.500	0.562	12.70	14.27	
L	0.045	0.060	1.15	1.52	
Ν	0.190	0.210	4.83	5.33	
Q	0.100	0.120	2.54	3.04	
R	0.080	0.110	2.04	2.79	
S	0.045	0.055	1.15	1.39	
Т	0.235	0.255	5.97	6.47	
U	0.000	0.050	0.00	1.27	
V	0.045		1.15		
Ζ		0.080		2.04	

STYLE 10: PIN 1. GATE

2. SOURCE DRAIN 3. SOURCE 4.

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